

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6166151

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
IAP RESEARCH, INC.	06/17/2020
RECEIVING PARTY DATA	
Name:	BAE SYSTEMS LAND & ARMAMENTS L.P.
Street Address:	34201 VAN DYKE AVENUE
City:	STERLING HEIGHTS
State/Country:	MICHIGAN
Postal Code:	48312
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	15427479
Patent Number:	9580790
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	MATTHEW R. JENKINS
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Address Line 4:	DAYTON, OHIO 45419
ATTORNEY DOCKET NUMBER:	IAP 069 P2 IAP 069 P2 CI
NAME OF SUBMITTER:	MATTHEW R. JENKINS
SIGNATURE:	/matthew r jenkins #34844 tlf/
DATE SIGNED:	06/23/2020
Total Attachments: 1	
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ASSIGNMENT OF UNITED STATES PATENT APPLICATIONS

WHEREAS, IAP Research, Inc. a corporation of the State of Ohio, with a place of business at 2763 Culver Avenue, Dayton, Ohio 45429 (hereinafter the Assignor), is the owner of the entire right, title and interest in and to the following applications for United States Letters Patents and the inventions therein contained, and is the owner of the entire right, title and interest in and to the following United States Letters Patents, and the inventions therein contained:

Serial No	Filed	Title	Docket
15/427,479	February 8, 2017	SYSTEM AND METHOD FOR SURFACE HARDENING OF REFRACTORY METALS	IAP 069 P2 CI
Patent No.	Issued	Title	Docket
9,580,790	February 28, 2017	SYSTEM AND METHOD FOR SURFACE HARDENING OF REFRACTORY METALS	IAP 069 P2

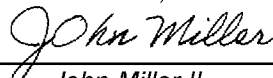
AND, WHEREAS, BAE Systems Land & Armaments L.P., a Limited Partnership of the State of Delaware, having a principal place of business at 34201 Van Dyke Avenue, Sterling Heights, Michigan 48312, (hereinafter the Assignee), is desirous of acquiring the entire right, title and interest in and to said applications and the inventions therein disclosed and any letters patents that may issue thereon, and is desirous of acquiring the entire right, title and interest in and to said United States Letters Patents and the inventions therein contained;

AND, WHEREAS, it is the intent of the Assignor to assign all rights, including but not limited to all substantive rights, to the above referenced application(s) and patent(s) to the Assignee;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable considerations, receipt of which is hereby acknowledged, the Assignor hereby sells, assigns and transfers to the Assignee, its successors and assigns, the entire right, title and interest in and to the aforementioned United States applications for letters patents and the inventions therein contained, and the entire right, title and interest in and to the aforementioned United States Letters Patents and the inventions therein contained, including any divisions, continuations, extensions, or reissues thereof, together with all rights of recovery for past, present and future infringements thereof; and said Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any reissues or extensions thereof to said Assignee, its successors and assigns, the same to be held and enjoyed by said Assignee, its successors and assigns, to the full end of the term for which said Letters Patents are granted and as fully and entirely as the same would have been enjoyed by the said Assignor had this sale, assignment and transfer not been made; and we hereby authorize said Assignee, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States applications or otherwise, and to secure in its own name the patent or patents issued thereon; and we hereby agree that, upon request, we will sign all papers, and make all rightful oaths, and do all acts which said Assignee, its successors or assigns, may consider necessary in connection with the said United States applications, and in connection with any other United States or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any patents issued or reissued thereon.

IN WITNESS WHEREOF, the Assignor has hereunto set its hand and seal as of the 17th day of June, 2020.

IAP RESEARCH, INC.


 By John Miller II
 Its Vice President & Secretary